19-3672; Rev 0; 5/05

MAXIM

50mA/100mA Current-Limit Switches with NO-LOAD Flag in µDFN

General Description

The MAX4826–MAX4831 family of switches has internal current limiting to prevent host devices from being damaged due to faulty load conditions. These analog switches have a low 0.7Ω on-resistance and operate from a +2.3V to +5.5V input voltage range. These devices are available with guaranteed 50mA and 100mA current limits, making them ideal for load-switching applications. In addition to the current-limit fault flag ($\overline{FFLG}$), an open-drain no-load flag indicator ($\overline{NOLD}$) notifies the system when the current through the switch is less than 10mA (MAX4826–MAX4829), or 5mA (MAX4830/MAX4831).

When the switch is on and a load is connected to the port, a guaranteed blanking time of 14ms ensures that the transient voltages settle down. If, after this blanking time, the load current is greater than the current limit, the MAX4826/MAX4828/MAX4830 enter a latch-off state where the switch is turned off, and $\overline{FFLG}$ is issued to the microprocessor. The switch can be turned on again by cycling the power or ON.

The MAX4827/MAX4829/MAX4831 have an autoretry feature where the switch turns off after the blanking time, and then continuously checks to see if the overload condition is present. The current-limit fault flag ($\overline{FFLG}$) is issued and remains low until after the fault condition is removed. The switch remains on after the overload condition disappears.

The MAX4826–MAX4831 operate over the extended -40°C to +85°C temperature range, and are available in a tiny space-saving, 1mm x 1.5mm, 6-pin µDFN package.

Features

- **Guaranteed Current Limit: 50mA, 100mA**
- **Thermal Shutdown Protection**
- **Reverse-Current Protection**
- **0.7Ω On-Resistance (MAX4826–MAX4831)**
- **14ms Guaranteed Blanking Time**
- **Fault Flag ($\overline{FFLG}$)**
- **No-Load Flag ($\overline{NOLD}$)**
- **65µA Supply Current**
- **8µA Latch-Off Current**
- **0.01µA Shutdown Current**
- **+2.3V to +5.5V Supply Range**
- **Undervoltage Lockout**
- **Fast Current-Limit Response Time**
- **6-Pin µDFN Package (1mm x 1.5mm)**

Applications

GPS Systems

Cell Phones

Digital Still Cameras

PDAs and Palmtop Devices

MP3 Players

Ordering Information/Selector Guide

PART	PIN-PACKAGE	MIN FULL-LOAD LIMIT (mA)	MAX NO-LOAD LIMIT (mA)	ON-RESISTANCE (Ω) T_A = +25°C	MODE	TOP MARK	PKG CODE
MAX4826ELT	6 µDFN	50	10	1	Latch Off	AK	L611-1
MAX4827ELT*	6 µDFN	50	10	1	Autoretry	AL	L611-1
MAX4828ELT*	6 µDFN	100	10	1	Latch Off	AM	L611-1
MAX4829ELT	6 µDFN	100	10	1	Autoretry	AN	L611-1
MAX4830ELT	6 µDFN	50	5	2	Latch Off	AO	L611-1
MAX4831ELT*	6 µDFN	50	5	2	Autoretry	AP	L611-1

Note: *All devices operate over the -40°C to +85°C operating range.*

**Future product—contact factory for availability.*

Pin Configuration appears at end of data sheet.

50mA/100mA Current-Limit Switches with NO-LOAD Flag in µDFN

ABSOLUTE MAXIMUM RATINGS

IN, ON, $\overline{FFLG}$, $\overline{NOLD}$, OUT to GND .....-0.3V to +6V
OUT Short Circuit to GND.....Internally Limited
Continuous Power Dissipation (T_A = +70°C)
6-Pin µDFN (derate 2.1mW/C above +70°C).....168mW
Operating Temperature Range .....-40°C to +85°C
Junction Temperature.....+150°C
Storage Temperature Range .....-65°C to +150°C
Lead Temperature (soldering, 10s) .....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{IN} = +2.3V to +5.5V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{IN} = +3.3V, T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Operating Voltage	V_{IN}			2.3		5.5	V
Quiescent Current	I_Q	V_{ON} = V_{IN}, I_{OUT} = 0, switch on	V_{IN} = +2.3V to +5.0V		65	100	µA
			V_{IN} = +5.0V to +5.5V			120	
Latch-Off Current (Note 2)	I_{LATCH}	V_{ON} = V_{IN} = 3.3V, after an overcurrent fault (MAX4826/MAX4828/MAX4830)			8	15	µA
Shutdown Current	I_{SHDN}	V_{ON} = 0, I_{OUT} = 0mA			0.01	1	µA
Shutdown Reverse Leakage	I_{SHDNRV}	V_{ON} = 0, V_{IN} = +2.3V, V_{OUT} = +5.5V			0.01	1	µA
Forward-Current Limit	I_{FWD}	(MAX4826/MAX4827/MAX4830/MAX4831) R_L = 10Ω		50		120	mA
		(MAX4828/MAX4829) R_L = 5Ω		100		240	
Reverse-Current Limit	I_{REV}	V_{OUT} - V_{IN} < 0.5V (MAX4826/MAX4827/MAX4830/MAX4831)				120	mA
		V_{OUT} - V_{IN} < 0.5V (MAX4828/MAX4829)				240	
No-Load Threshold	I_{NLTH}	MAX4826–MAX4829		1.0		10.0	mA
		MAX4830/MAX4831		0.5		5.0	
ON Input Leakage	I_{ONLK}	V_{ON} = V_{IN} or GND		-1		+1	µA
Off-Switch Leakage	I_{SWLK}	V_{IN} = +5.5V, V_{ON} = 0, V_{OUT} = 0			0.01	1	µA
Undervoltage Lockout	UVLO	Rising edge		1.8		2.2	V
Undervoltage Lockout Hysteresis	$UVLO_{HYS}$				100		mV
On-Resistance	R_{ON}	T_A = +25°C, I_{OUT} = 20mA	(MAX4826–MAX4829)		0.7	1.0	Ω
			(MAX4830/MAX4831)		1.4	2.0	
		T_A = -40°C to +85°C, I_{OUT} = 20mA	(MAX4826–MAX4829)			1.3	
			(MAX4830/MAX4831)			2.6	
ON Input-Logic-High Voltage	V_{IH}			2.0			V
ON Input-Logic-Low Voltage	V_{IL}					0.8	V
$\overline{FFLG}$, $\overline{NOLD}$ Output-Logic-Low Voltage		I_{SINK} = 1mA				0.4	V

ELECTRICAL CHARACTERISTICS (continued)

(V_{IN} = +2.3V to +5.5V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{IN} = +3.3V, T_A = +25°C.) (Note 1)

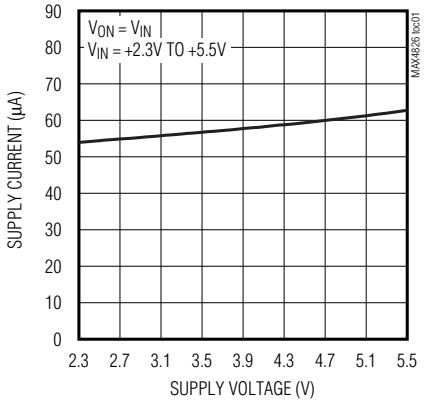
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
$\overline{FFLG}$, $\overline{NOLD}$ Output-High Leakage Current		V_{IN} = $V_{\overline{FFLG}}$ = $V_{\overline{NOLD}}$ = +5.5V			1	µA
Thermal Shutdown				+150		°C
Thermal-Shutdown Hysterisis				15		°C
DYNAMIC						
Turn-On Time		ON from low to high; I_{OUT} = 10mA, C_L = 0.1µF (Note 3)		50		µs
Turn-Off Time		ON from high to low; I_{OUT} =10mA, C_L = 0.1µF (Note 3)		30		ns
Blanking Time	t_{BLANK}	Overcurrent fault	14		60	ms
Short-Circuit Current-Limit Response Time		V_{ON} = V_{IN} = +3.3V, short circuit applied to OUT		5		µs
No-Load-Detection Response Time		I_{OUT} falling step signal from 15mA to 0mA, C_L = 0.1µF		60		µs
Retry Time	t_{RETRY}	Overcurrent fault (Figure 2) (Note 4)	196		840	ms

Note 1: All parts are 100% tested at T_A = +25°C. Limits at T_A = -40°C to +85°C are guaranteed by design.
Note 2: Latch-off current does not include the current flowing into $\overline{FFLG}$ and $\overline{NOLD}$.
Note 3: Turn-on time is defined as the time taken for the current through the switch to go from 0mA to full load. Turn-off time is defined as the time taken for the current through the switch to go from full load to 0mA.
Note 4: Retry time is typically 14x the blanking time.

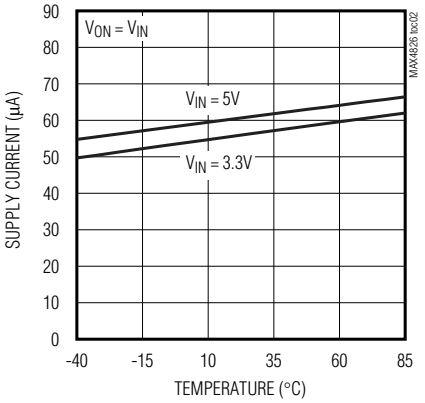
Typical Operating Characteristics

(V_{IN} = +3.3V, T_A = +25°C, unless otherwise noted.)

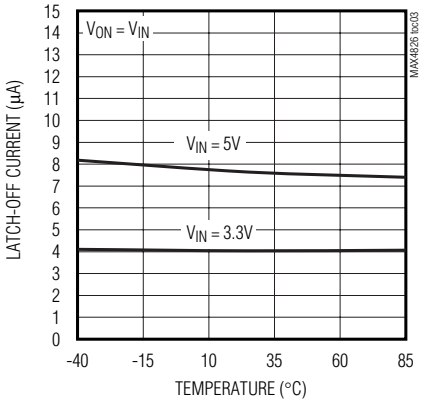
QUIESCENT SUPPLY CURRENT vs. SUPPLY VOLTAGE



QUIESCENT SUPPLY CURRENT vs. TEMPERATURE



LATCH-OFF CURRENT vs. TEMPERATURE

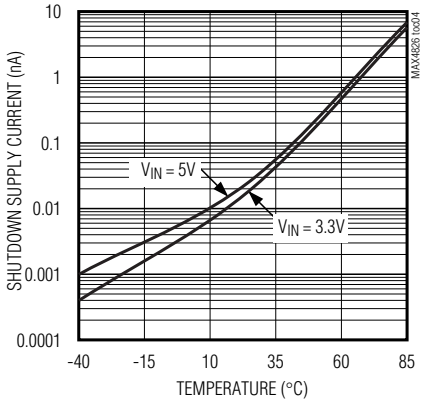


50mA/100mA Current-Limit Switches with NO-LOAD Flag in µDFN

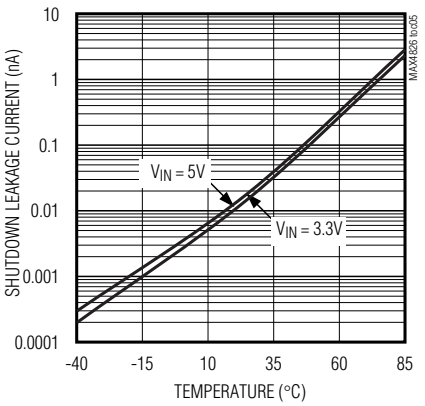
Typical Operating Characteristics (continued)

(V_{IN} = +3.3V, T_A = +25°C, unless otherwise noted.)

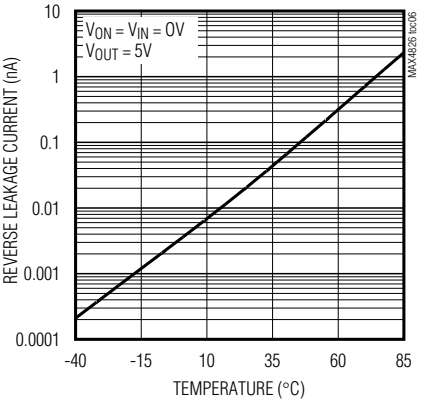
SHUTDOWN SUPPLY CURRENT vs. TEMPERATURE



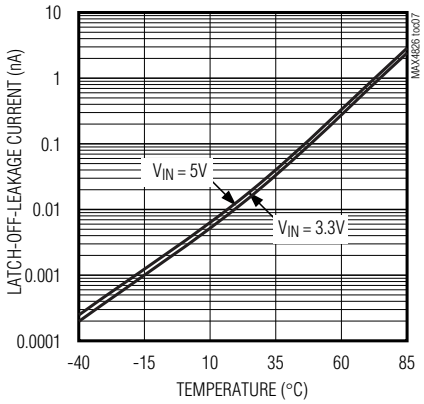
SHUTDOWN LEAKAGE CURRENT vs. TEMPERATURE



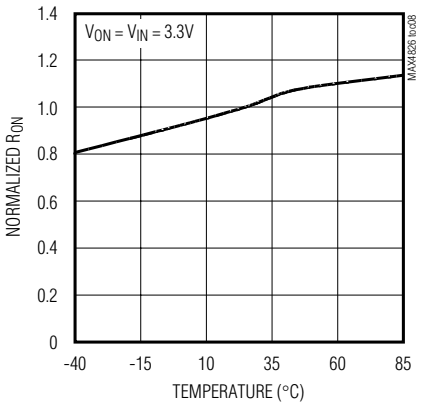
SHUTDOWN REVERSE LEAKAGE CURRENT vs. TEMPERATURE



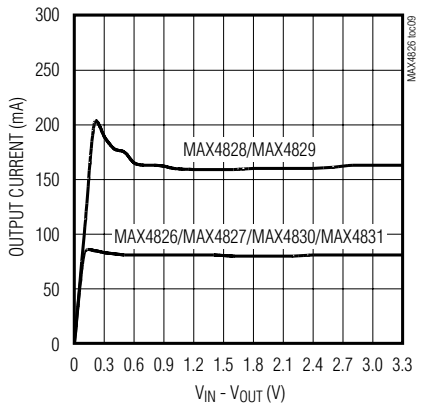
LATCH-OFF-LEAKAGE CURRENT vs. TEMPERATURE



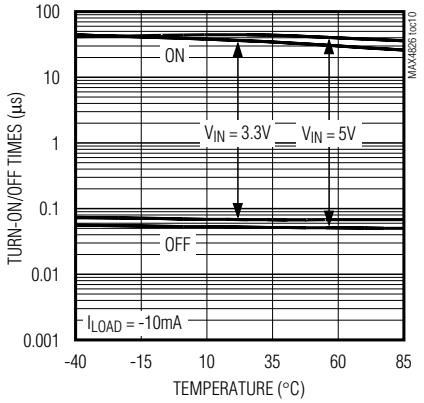
NORMALIZED ON-RESISTANCE vs. TEMPERATURE



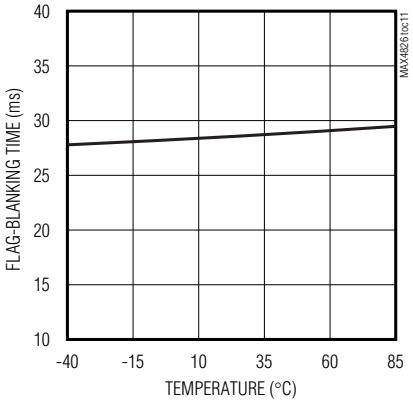
OUTPUT CURRENT vs. OUTPUT VOLTAGE



SWITCH TURN-ON/OFF TIMES vs. TEMPERATURE



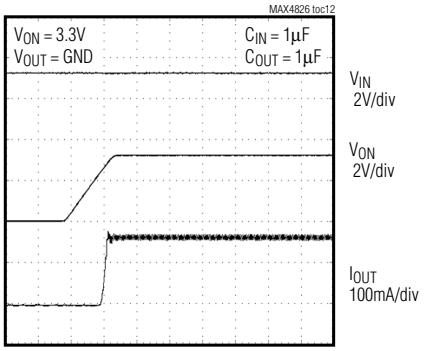
FLAG-BLANKING TIMEOUT vs. TEMPERATURE



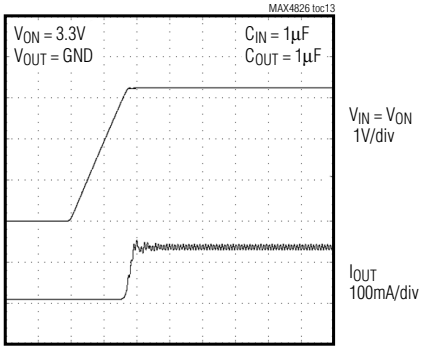
Typical Operating Characteristics (continued)

(V_{IN} = +3.3V, T_A = +25°C, unless otherwise noted.)

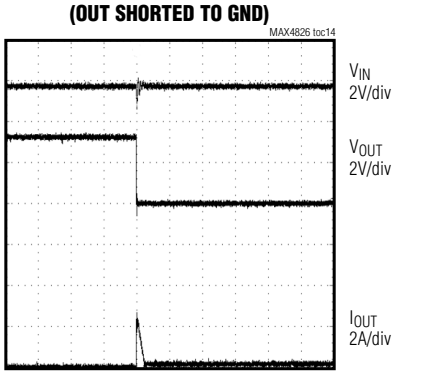
CURRENT-LIMIT RESPONSE



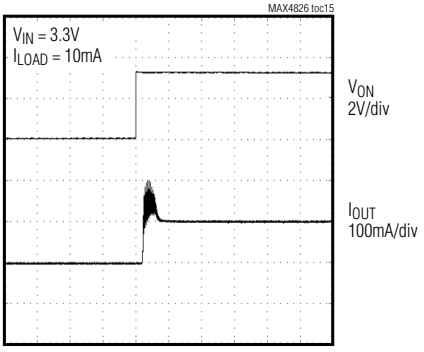
CURRENT-LIMIT RESPONSE



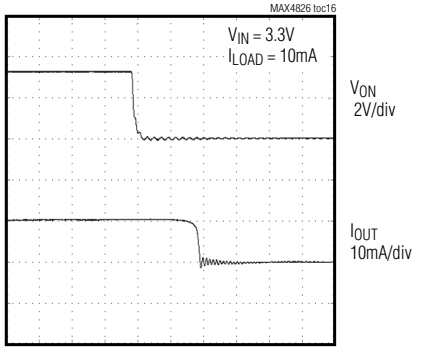
CURRENT-LIMIT RESPONSE (OUT SHORTED TO GND)



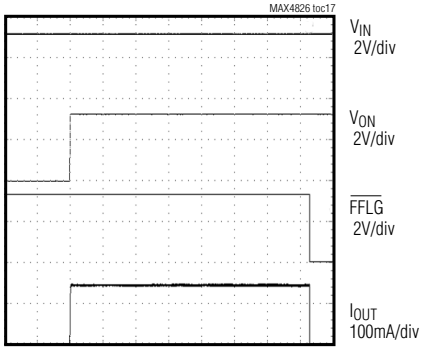
SWITCH TURN-ON-TIME RESPONSE



SWITCH TURN-OFF-TIME RESPONSE



FLAG-BLANKING RESPONSE



50mA/100mA Current-Limit Switches with NO-LOAD Flag in µDFN

Pin Description

PIN	NAME	FUNCTION
1	IN	Input. Bypass IN with a 0.1µF ceramic capacitor to ground.
2	GND	Ground
3	OUT	Switch Output. Bypass OUT with a 0.1µF capacitor to ground
4	$\overline{FFLG}$	Current-Limit Fault Output. $\overline{FFLG}$ is an open-drain output. $\overline{FFLG}$ goes low when the device stays in forward- or reverse-current limit for more than the blanking time period. $\overline{FFLG}$ is high impedance when a fault is not present or when ON is low.
5	$\overline{NOLD}$	No-Load Flag Output. $\overline{NOLD}$ is an open-drain output. $\overline{NOLD}$ goes low when a load of less than 10mA (MAX4826–MAX4829) or 5mA (MAX4830/MAX4831) is delivered to the output. $\overline{NOLD}$ is high impedance when a fault is not present or when ON is low.
6	ON	Active-High Switch-On Input. Drive ON high to turn the switch on.

Detailed Description

The MAX4826–MAX4831 are forward-/reverse-current-limited switches that operate from a +2.3V to +5.5V input voltage range and guarantee a 50mA and 100mA minimum current-limit threshold for different options. The voltage drop across an internal sense resistor is compared to two reference voltages to indicate a forward- or reverse-current-limit fault. When the load current exceeds the preset current limit for greater than the fault-blanking time, the switch opens.

The MAX4827/MAX4829/MAX4831 have an autoretry function that turns on the switch again after an internal retry time expires. If the faulty load condition is still present after the blanking time, the switch turns off again and the cycle is repeated. If the faulty load condition is not present, the switch remains on.

The MAX4826/MAX4828/MAX4830 do not have the autoretry option, and the switch remains in latch-off mode until ON or the input power is cycled from high to low and then high again.

The undervoltage lockout (UVLO) circuit prevents erroneous switch operation when the input voltage goes too low during startup conditions.

Reverse-Current Protection

The MAX4826–MAX4831 limit the reverse current (V_{OUT} to V_{IN}) from exceeding the maximum I_{REV} value. The switch is shut off and $\overline{FFLG}$ is asserted if the reverse-current-limit condition persists for more than the blanking time. This feature prevents excessive reverse currents from flowing through the device.

Switch-On/Off Control

Toggle ON high to enable the current-limited switches. The switches are continuously on only if V_{IN} exceeds the UVLO threshold (typically 2V) and there is no fault. When a forward-/reverse-current fault is present or the die exceeds the thermal-shutdown temperature of +150°C, OUT is internally disconnected from IN, and the supply current decreases to 8µA (latch off). The switch is now operating in one of its off states. The switch off state also occurs when driving ON low, thus reducing the supply current (shutdown) to 0.01µA. Table 1 illustrates the ON/OFF state of the MAX4826–MAX4831 current-limit switches.

Table 1. MAX4826–MAX4831 Switch Truth Table

ON	FAULT	SWITCH ON/OFF	SUPPLY CURRENT MODE
Low	X	OFF	Shutdown
High	Undervoltage lockout	OFF	Latch off
High	Thermal	OFF immediately (t_{BLANK} period does not apply).	Latch off
High	Current limit	OFF after t_{BLANK} period has elapsed.	Latch off
		ON during t_{BLANK} period, OFF during t_{RETRY} period for the MAX4827/MAX4829/MAX4831. Cycle repeats until fault is removed.	See the *Autoretry* section

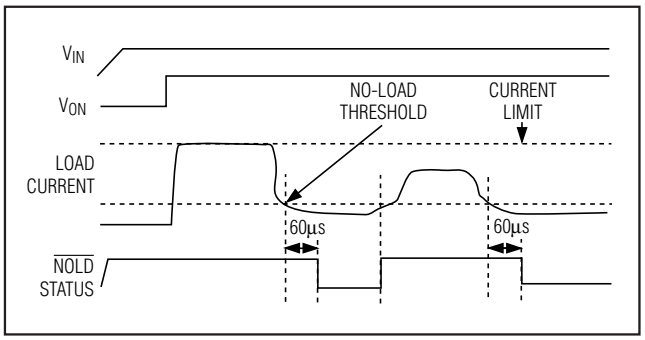


Figure 1. MAX4826–MAX4831 No-Load Flag Response

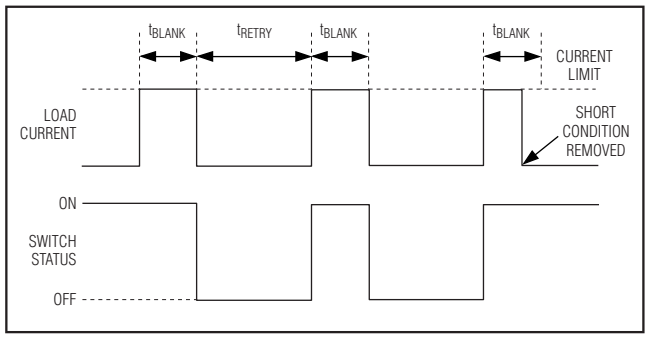


Figure 2. MAX4827/MAX4829/MAX4831 Autoretry Fault Blanking Diagram

FFLG Indicator

The MAX4826–MAX4831 feature a current-limit fault output, FFLG. Whenever a current-limit fault is activated, FFLG goes low and the switch turns off. FFLG is an open-drain output transistor and requires an external pullup resistor from FFLG to IN. During shutdown (ON is low), the pulldown on the FFLG output is released to limit power dissipation. FFLG goes low when any of the following conditions occur:

- The die temperature exceeds the thermal shutdown temperature limit of +150°C.
- The device is in current limit for more than the fault-blanking period.
- V_{IN} is below the UVLO threshold.

NOLD Indicator

The MAX4826–MAX4831 feature a no-load flag output, NOLD (Figure 1). This output is pulled low every time the current coming out of the switch is less than 10mA (MAX4826–MAX4829), or 5mA (MAX4830/MAX4831). NOLD is an open-drain output transistor and requires an external pullup resistor from NOLD to a supply up to +5.5V. Current through the switch is intended to be positive (from IN to OUT), and for currents that are large in magnitude but negative in sign (OUT to IN), NOLD asserts low. For options with the autoretry feature (MAX4827/MAX4829/MAX4831), the NOLD output is high impedance during the t_{RETRY} period when a forward-current-limit condition is present. However, NOLD is pulled low if a reverse current-limit condition is present during the t_{RETRY} period. A constant time filter is present at the output of NOLD that gives a 60µs delay when a no-load condition is asserted. Deassertion of NOLD is not delayed. During shutdown (ON is low), the pulldown on NOLD is released to limit power dissipation.

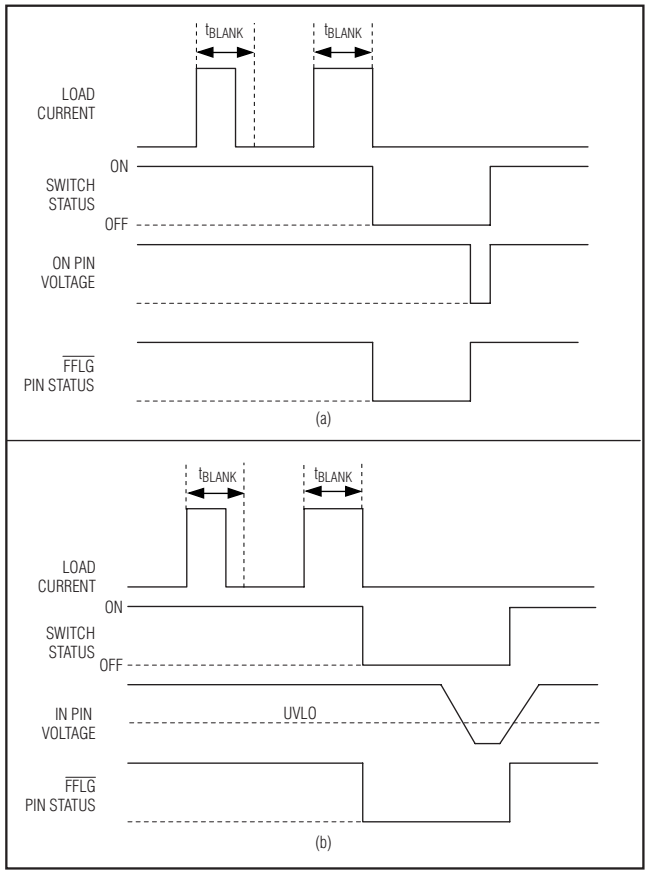


Figure 3. MAX4826/MAX4828/MAX4830 Latch-Off Fault Blanking

Autorety (MAX4827/MAX4829/MAX4831)

When the forward- or reverse-current-limit threshold is exceeded, the t_{BLANK} timer begins counting (Figure 2). The timer resets if the overcurrent condition disappears before t_{BLANK} has elapsed. A retry time delay, t_{RETRY},

50mA/100mA Current-Limit Switches with NO-LOAD Flag in µDFN

is started immediately after t_{BLANK} has elapsed, and during that time the switch is latched off. At the end of t_{RETRY}, the switch is turned on again. If the fault still exists, the cycle is repeated. If the fault has been removed, the switch stays on.

The autoretry feature saves system power in the case of an overcurrent or short-circuit condition. During t_{BLANK}, when the switch is on, the supply current is at the current limit. During t_{RETRY}, when the switch is off, no current flows through the switch. Instead of observing the full load current, the switch sees the equivalent load current, multiplied by the duty cycle or $I_{SUPPLY} = I_{LOAD} \times t_{BLANK} / (t_{BLANK} + t_{RETRY})$. With a typical t_{BLANK} = 37ms and typical t_{RETRY} = 518ms, the duty cycle is 6% which results in a 94% power savings, as opposed to the switch being on the entire time. The duty cycle is consistent across the process and devices.

Latch Off (MAX4826/MAX4828/MAX4830)

When the forward- or reverse-current-limit threshold is exceeded, the t_{BLANK} timer begins counting. The timer resets if the overcurrent condition disappears before t_{BLANK} has elapsed. The switch is shut off if the overcurrent condition continues up to the end of the blanking time. Reset the switch by either toggling ON (Figure 3a), or cycling the input voltage below UVLO, typically 2V (Figure 3b).

Fault Blanking

The MAX4826–MAX4831 feature 14ms (min) fault blanking. Fault blanking allows current-limit faults, including momentary short-circuit faults that occur when hot swapping a capacitive load. Fault blanking also ensures that no fault is issued during power-up. When a load transient causes the device to enter the current limit, an internal counter starts. If the load-transient fault persists beyond the fault-blanking timeout, $\overline{FFLG}$ asserts low. Load-transient faults less than t_{BLANK} do not cause $\overline{FFLG}$ assertion. Only current-limit faults are blanked.

A thermal fault and input voltage drops below the UVLO threshold cause $\overline{FFLG}$ to assert immediately. These faults do not wait for the blanking time.

Thermal Shutdown

The MAX4826–MAX4831 have a thermal-shutdown feature to protect the devices from overheating. The switch turns off and $\overline{FFLG}$ goes low immediately (no fault blanking) when the junction temperature exceeds +150°C. The switches with the autoretry feature turn back on when the device temperature drops approximately 15°C. The switches with the latch-off feature require ON cycling.

Applications Information

Input Capacitor

To limit the input voltage drop during momentary output short-circuit conditions, connect a capacitor from IN to GND. A 0.1µF ceramic capacitor is adequate for most applications; however, higher capacitor values further reduce the voltage drop at the input and are recommended for lower voltage applications.

Output Capacitance

Connect a 0.1µF capacitor from OUT to GND. This capacitor helps prevent inductive parasitics from pulling OUT negative during turn-off, thus preventing the MAX4826–MAX4831 from tripping erroneously. If the load capacitance is too large, current may not have enough time to charge the capacitance, and the device assumes that there is a faulty load condition. The maximum capacitive load value that can be driven from OUT is obtained by the following formula:

$$C_{MAX} < \frac{I_{FWD\_MIN} \times t_{BLANK\_MIN}}{V_{IN}}$$

Layout and Thermal Dissipation

To optimize the switch response time to output short-circuit conditions, it is very important to keep all traces as short as possible to reduce the effect of undesirable parasitic inductance. Place input and output capacitors as close as possible to the device (no more than 5mm). IN and OUT pins must be connected with short traces to the power bus.

During normal operation, the power dissipation is small and the package temperature change is minimal. If the output is continuously shorted to ground at the maximum supply voltage, the operation of the switches with the autoretry option does not cause problems because the total power dissipated during the short is scaled by the duty cycle:

$$P_{MAX} < \frac{V_{IN\_MAX} \times I_{OUT\_MAX} \times t_{BLANK}}{t_{RETRY} + t_{BLANK}} = 88mW$$

where,

V_{IN_MAX} = 5.5V, I_{OUT_MAX} = 240mA, t_{BLANK} = 37ms, and t_{RETRY} = 518ms.

Attention must be given to the MAX4826/MAX4828/MAX4830 where the latch-off condition must be manually reset by toggling ON from high to low. If the latch-off time duration is not sufficiently high, it is possible for the device to reach the thermal shutdown threshold and never be able to turn the device on until it cools down.

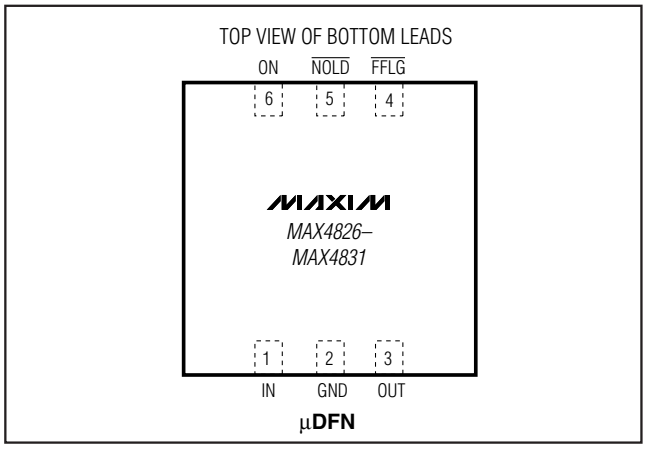
50mA/100mA Current-Limit Switches with NO-LOAD Flag in µDFN

Chip Information

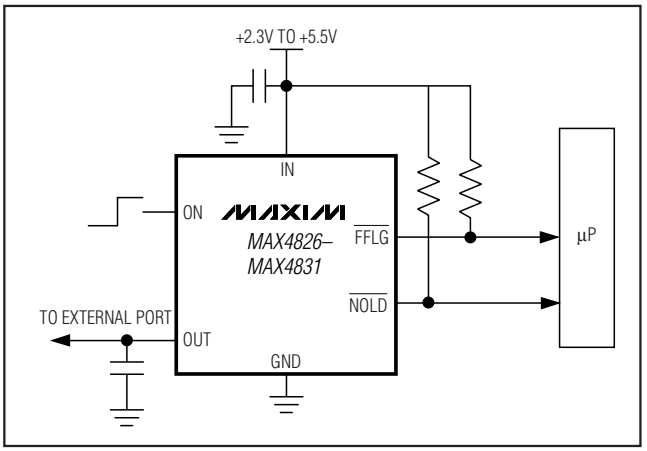
TRANSISTOR COUNT: 1175

PROCESS: BiCMOS

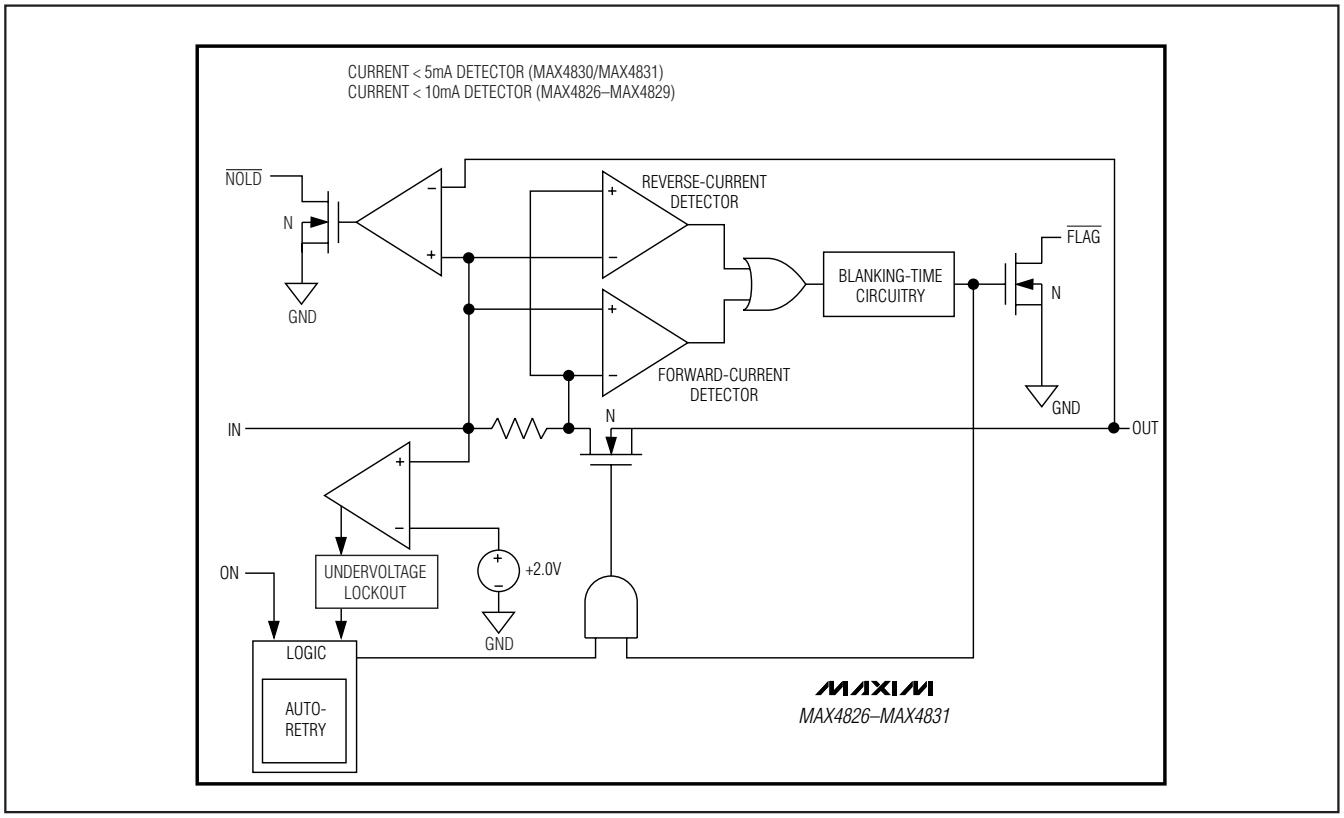
Pin Configuration



Typical Operating Circuit



Functional Diagram



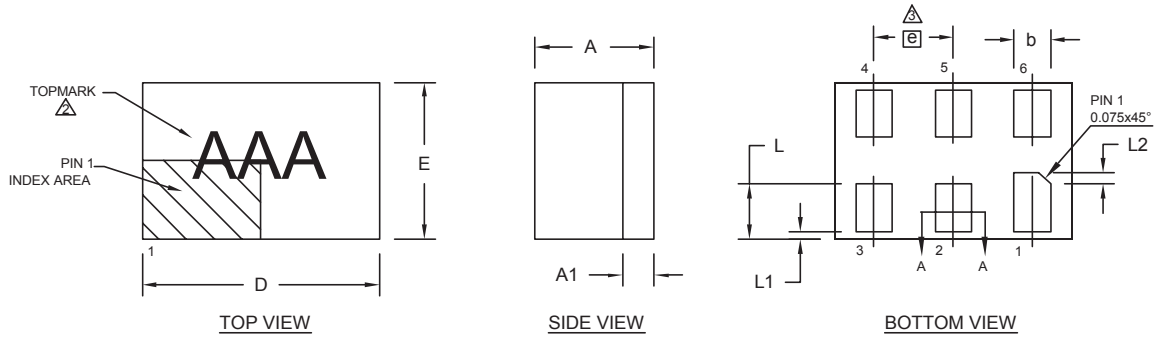
MAX4826–MAX4831

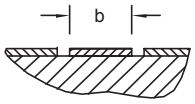
50mA/100mA Current-Limit Switches with NO-LOAD Flag in µDFN

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

6L UDFN.EPS





SECTION A-A

SYMBOL	COMMON DIMENSIONS		
	MIN.	NOM.	MAX.
A	0.64	0.72	0.80
A1	--	0.20	--
D	1.45	1.50	1.55
E	0.95	1.00	1.05
L	0.30	0.35	0.40
L1	--	--	0.08
L2	--	--	0.05
b	0.17	0.20	0.23
e	0.50 BSC.		

NOTES:
1. DIMENSIONS ARE IN MILLIMETERS.
2. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
3. LEAD CENTERLINES TO BE AT TRUE POSITION AS DEFINED BY BASIC DIMENSION "e", ±0.05.

-DRAWING NOT TO SCALE-

DALLAS SEMICONDUCTOR MAXIM

TITLE: PACKAGE OUTLINE, 6L uDFN, 1.5x1.0x0.8mm

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0147	C	1/1

MAX4827

Part Number Table

Notes:

1. See the MAX4827 QuickView Data Sheet for further information on this product family or download the MAX4827 full data sheet (PDF, 620kB).
2. Other options and links for purchasing parts are listed at: http://www.maxim-ic.com/sales.
3. Didn't Find What You Need? Ask our applications engineers. Expert assistance in finding parts, usually within one business day.
4. Part number suffixes: T or T&R = tape and reel; + = RoHS/lead-free; # = RoHS/lead-exempt. More: See full data sheet or Part Naming Conventions.
5. * Some packages have variations, listed on the drawing. "PkgCode/Variation" tells which variation the product uses.

Part Number	Free Sample	Buy Direct	**Package:** TYPE PINS SIZE DRAWING CODE/VAR *	Temp	RoHS/Lead-Free? Materials Analysis
MAX4827ELT			MicroDFN;6 pin;1.0x1.5mm Dwg: 21-0147E (PDF) Use pkgcode/variation: L611-1*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis
MAX4827ELT-T			MicroDFN;6 pin;1.0x1.5mm Dwg: 21-0147E (PDF) Use pkgcode/variation: L611-1*	-40C to +85C	RoHS/Lead-Free: No Materials Analysis

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